August 2008



FDS7788 30V N-Channel PowerTrench^o MOSFET

General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for "low side" synchronous rectifier operation, providing an extremely low $R_{DS(ON)}$ in a small package.

Applications

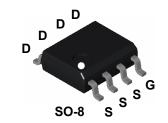
- DC/DC converter
- · Load switch
- Motor drives

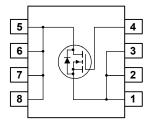


Features

• 18 A, 30 V. $R_{DS(ON)} = 4.0 \ m\Omega \ @ V_{GS} = 10 \ V$ $R_{DS(ON)} = 5.0 \ m\Omega \ @ V_{GS} = 4.5 \ V$

- Low gate charge
- · Fast switching speed
- High power and current handling capability
- High performance trench technology for extremely low R_{DS(ON)}
- RoHS Compliant





Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol		Parameter		Ratings	Units
V _{DSS}	Drain-Source	urce Voltage		30	V
V _{GSS}	Gate-Source	Voltage		±20	V
D	Drain Currer	t – Continuous	(Note 1a)	18	A
		– Pulsed		50	
AS	Drain-Source	e Avalanche Energy	(Note 3)	661	mJ
PD	Power Dissipation for Single Operation		ON (Note 1a)	2.5	W
			(Note 1b)	1.2	
			(Note 1c)	1.0	
Γ _J , T _{STG}	Operating ar	Operating and Storage Junction Temperature Range		-55 to +150	°C
Therma	I Charact	eristics			
R _{eJA}	Thermal Res	istance, Junction-to-Aml	bient (Note 1a)	50	°C/W
ર ₀JC	Thermal Res	ermal Resistance, Junction-to-Case		30	°C/W
Packag	e Marking	and Ordering	Information		
Device	Marking	Device	Reel Size	Tape width	Quantity
FDS7788		FDS7788	13"	12mm	2500 units

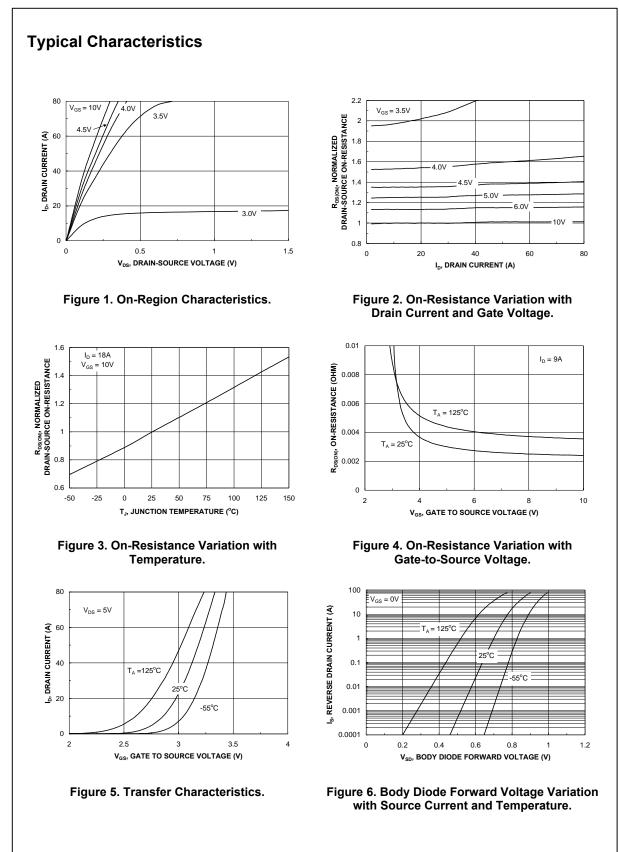
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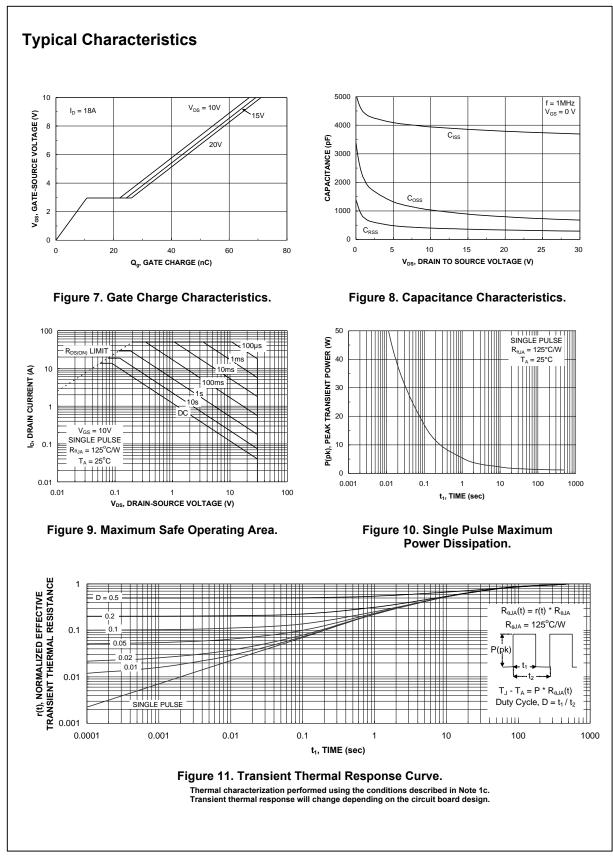
FDS7788 Rev F1 (W)

	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics					
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V, I_D = 250 \mu A$	30			V
<u>ΔBVdss</u> ΔTj	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25° C		25		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 24 V, V_{GS} = 0 V$			10	μΑ
I _{GSSF}	Gate-Body Leakage, Forward	ate-Body Leakage, Forward $V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
I _{GSSR}	Gate-Body Leakage, Reverse	$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA
On Chara	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1	1.9	3	V
$rac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		-5.4		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance			3.0 3.8 4.3	4.0 5.0 6.3	mΩ
I _{D(on)}	On-State Drain Current	$V_{GS} = 10 \text{ V}, V_{DS} = 5 \text{ V}$	30			А
g FS	Forward Transconductance	$V_{DS} = 10 \text{ V}, I_D = 18 \text{ A}$		112		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance	pacitance $V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V},$		3845		pF
Coss	Output Capacitance	f = 1.0 MHz		930		pF
C _{rss}	Reverse Transfer Capacitance	1		368		pF
R _G	Gate Resistance	V _{GS} = 15 mV, f = 1.0 MHz		1.4		Ω
Switchin	g Characteristics (Note 2)		•			
t _{d(on)}	Turn–On Delay Time	$V_{DD} = 15 V$, $I_D = 1 A$,		15	27	ns
t _r	Turn–On Rise Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		13	23	ns
t _{d(off)}	Turn–Off Delay Time			62	99	ns
t _f	Turn–Off Fall Time	1		36	58	ns
Q _g	Total Gate Charge			37	48	nC
Q _{gs}	Gate-Source Charge			10		nC
Q _{gd}	Gate–Drain Charge			14		nC
Drain-Sc	ource Diode Characteristics	and Maximum Ratings				
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_S = 2.1 \text{ A} (\text{Note 2})$		0.7	1.2	V
t _{rr}	Diode Reverse Recovery Time	I _F = 18 A,		39		nS
Q _{rr}	Diode Reverse Recovery Charge	d _{iF} /d _t = 100 A/µs		33		nC

3. Starting T_J = 25°C, L = 3mH, I_{AS} = 21A, V_{DD} = 30V, V_{GS} = 10V

FDS7788 Rev F1 (W)







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